

PRODUCT : CAMERA MODULE

MODEL NO. : CM8119-A500SA-E

SUPPLIER : TRULY SEMICONDUCTORS LTD.

DATE : September 24, 2008



CERT. No. 946535
ISO9001
TL9000

SPECIFICATION

Revision: 1.0

CM8119-A500SA-E

If there is no special request from customer, TRULY SEMICONDUCTORS Co., Ltd will not reserve the tooling of the product under the following conditions:

1. There is no response from customer in two years after TRULY SEMICONDUCTORS Co., Ltd submit the samples;

2. There is no order in two years after the latest mass production.

And correlated data (include quality record) will be reserved one year more after tooling was discarded.

TRULY SEMICONDUCTORS LTD:

CUSTOMER:

Quality Assurance Department: _____

Approved by:

Technical Department: _____

Approved by:

CONTENTS

- KEY INFORMATION
- PIN ASSIGNMENT
- ELECTRICAL CHARACTERISTICS
- MECHANICAL DRAWING
- APPEARANCE SPECIFICATION
- IMAGE SPECIFICATION
- QA PLAN
- PRECAUTIONS FOR USING CCM MODULES
- PACKAGE SPECIFICATION
- PRIOR CONSULT MATTER
- FACTORY CONTACT INFORMATION

WRITTEN BY	CHECKED BY	APPROVED BY
HUANG WEI NA	WEI YOU XING	LIU TIE NAN

Key Information

Module No.		CM8119-A500SA-E
Module Size		10.0mm X 10.0mm X 6.80-7.05mm
Image Quality		≥1000 TV line
Sensor Type		OV5630
Array Size	QSXGA	2592 X 1944
Power supply	core	1.5VDC +/-5%
	Analog	2.6~3.1 VDC
	I/O	1.7~3.1V
Lens		1/3.2 inch 4Plastic+ IR
Focus(F.NO)		2.8
View Angle		60.1°
Image Area		TBD
Object distance		10cm-infinity
Sensitivity		TBD
Pixel size		1.75μm x 1.75μm
IR Cutter		650+/-10nm
Sensor Temperature Range	Operating	-30° C to 70° C
	Stable Image	0° C to 50° C
Output Formats(10-bit)		10-bit RGB RAW output
Maximum Image Transfer Rate	QSXGA	15 fps
	VGA	60 fps
	QVGA	120 fps
S/N Rate		TBD
Dynamic Range		80dB
substrate		FPC
IC Package		58-pin CSP2
Power requirement	Active	TBD
	Standby	TBD
Fixed Pattern noise		TBD
Scan Mode		Progressive
Dark current		TBD
Package		Antistatic Plastic

Pin Assignment

No.	Name	Pin type	Description
1	AF_VDD	Power	Power supply for VCM
2	AGND	Ground	Ground for analog circuit
3	SIO_D	I/O	SCCB data
4	AVDD	Power	Analog power(2.6-3.1V)
5	SIO_C	Input	SCCB clock
6	RESET	Input	Hardware reset active low
7	VSYN	I/O	Vertical synchronization output
8	PWDN	Input	Power down (hardware standby)
9	HREF	I/O	Horizontal reference output
10	PD	Input	Power down, VCM Driver IC asynchronous power-down signal. active Low
11	DOVDD	Power	Power for I/O circuit
12	Y9	I/O	Video port output bit[9]
13	XCLK	Input	System clock input
14	Y8	I/O	Video port output bit[8]
15	GND	Ground	ground
16	Y7	I/O	Video port output bit[7]
17	PCLK	I/O	Pixel clock output input
18	Y6	I/O	Video port output bit[6]
19	Y2	I/O	Video port output bit[2]
20	Y5	I/O	Video port output bit[5]
21	Y3	I/O	Video port output bit[3]
22	Y4	I/O	Video port output bit[4]
23	Y1	I/O	Video port output bit[1]
24	Y0	I/O	Video port output bit[0]

Electrical Characteristics

1. Absolute Maximum Ratings

parameter		absolute maximum rating ^a
stable operating temperature		0°C to +50°C
operating temperature		-30°C to +70°C
ambient storage temperature		-40°C to +125°C
ambient humidity		TBD
supply voltage (with respect to ground)	V _{DD-A}	4.5V
	V _{DD-C}	3V
	V _{DD-IO}	4.5V
electro-static discharge (ESD)	human body model	2000V
	machine model	200V
all input/output voltages (with respect to ground)		-0.3V to V _{DD-IO} + 1V

- a. exceeding the absolute maximum ratings shown above invalidates all AC and DC electrical specifications and may result in permanent damage to the device.

2. DC Characteristics (-30°C < Ta < 70°C)

symbol	parameter	min	typ	max	unit
supply					
V _{DD-A}	supply voltage (analog)	2.6	2.8	3.1	V
V _{DD-S}	supply voltage (pixel)	2.6	2.8	3.1	V
V _{DD-D}	supply voltage (digital I/O)	1.7 2.6	1.8 2.8	3.1 3.1	V
V _{DD-DO}	supply voltage (digital core) ^a	1.425	1.5	1.575	V
V _{DD-E}	supply voltage (MIPI)	1.425	1.5	1.575	V
I _{DD-A}	active (operating) current 2592 x 1944 @ 10 fps ^b	TBD	60	TBD	mA
I _{DD-S}		TBD	10	TBD	mA
I _{DD-DO}		TBD	90	TBD	mA
I _{DD-A}	active (operating) current 1280 x 720 @ 60 fps ^b	TBD	60	TBD	mA
I _{DD-S}		TBD	10	TBD	mA
I _{DD-DO}		TBD	60	TBD	mA
I _{DD-S-SCCB}	standby current	TBD	TBD	TBD	mA
I _{DD-S-PWDN}		TBD	TBD	TBD	μA
digital inputs (typical conditions: AVDD = 2.8V, DVDD = 1.5V, DOVDD = 1.8V)					
V _{IL}	input voltage LOW			0.54	V
V _{IH}	input voltage HIGH	1.26			V
C _{IN}	input capacitor			10	pF
digital outputs (standard loading 25 pF)					
V _{OH}	output voltage HIGH	1.62			V
V _{OL}	output voltage LOW			0.18	V
serial interface inputs					
V _{IL} ^c	SCL and SDA	-0.5	0	0.54	V
V _{IH} ^c	SCL and SDA	1.26	1.8	2.3	V

a. when internal regulator is bypassed

b. using internal regulator for DVDD and short DVDD with EVDD; DOVDD = 2.8V

c. based on DOVDD = 1.8V

3. AC Characteristics (T_A=25°C, V_{DD-A}=2.8V)

symbol	parameter	min	typ	max	unit
ADC parameters					
B	analog bandwidth		30		MHz
DLE	DC differential linearity error		0.5		LSB
ILE	DC integral linearity error		1		LSB
	setting time for hardware reset			<1	ms
	setting time for software reset			<1	ms
	setting time for resolution mode change			<1	ms
	setting time for register setting			<300	ms

4. Timing Characteristics

symbol	parameter	min	typ	max	unit
oscillator and clock input					
f_{osc}	frequency (XVCLK)	6	24	27	MHz
t_r, t_f	clock input rise/fall time			5 (10 ³)	ns

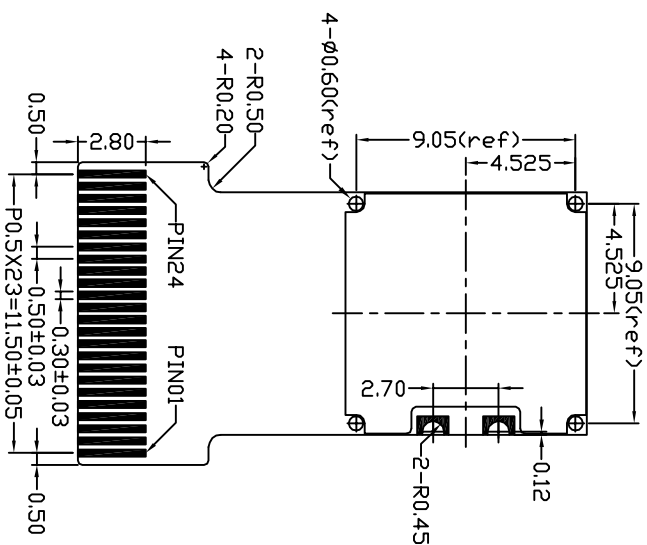
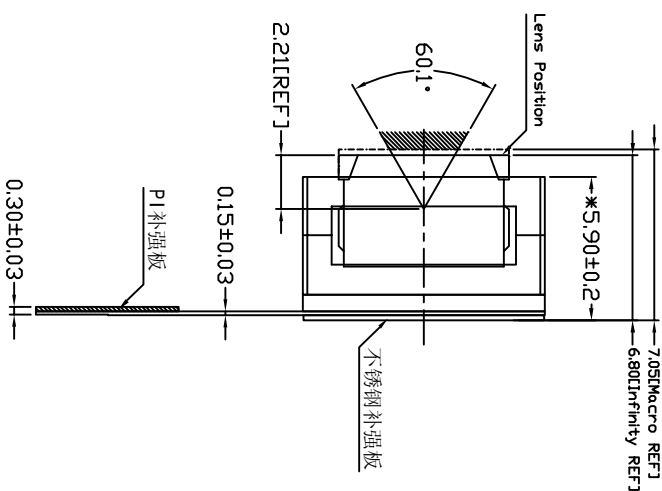
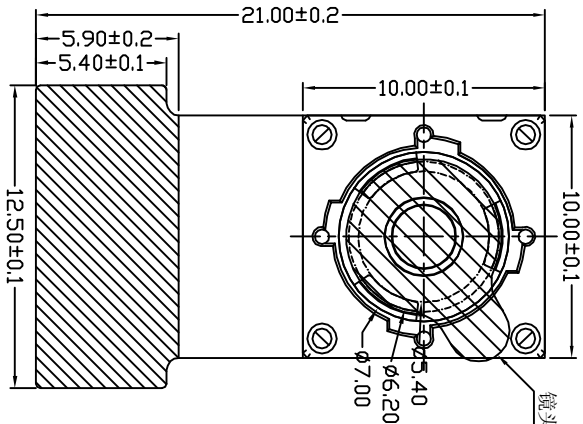
a. if using the internal PLL

Note: For more information of sensor please refer to the OV5630 specification.

ROHS

CM8119-A500SA-E Camera Module

Customer No.:



24PIN DESCRIPTION

PIN NO.	SIGNAL
1	AF_VDD
2	AGND
3	S10D
4	AVDD
5	S10C
6	RESET
7	VSYNC
8	PIWDN
9	HREF
10	PD
11	DOVDD
12	Y9
13	XCLK
14	Y8
15	GND
16	Y7
17	PCLK
18	Y6
19	Y2
20	Y5
21	Y3
22	Y4
23	Y1
24	Y0

Lens Specification	
EFL	4.79mm
F.NO	2.8
Field Of View	60.1°
Distortion	<1%
Image Quality	≥1000TV Line
Chip Type	OV5630
Array Size	5.0M
Lens Size	1/3.2 INCH
Lens Construction	4P+IR
Focus Area	10cm-infinity

Actuator Specification	
Type	VCM Parameter
Control Mode	IIC
Supply Voltage	2.8V~3.3 V
Coil Resistance	20±10% ohm
Rated Current	under 80mA
Lens Movement	0.25mm or more

- 备注:
- 带*尺寸为关键尺寸;
 - 未标注圆角为R0.2.

CUSTOMER APPROVE	
Mechanical	Electrical
△	△
△	△
△	△
ND	ND

AMEND	
CONTENT	DATE

TRULY SEMICONDUCTORS LTD.	
PRODUCT NO.	DRAW NO.
CM8119-A500SA-E	标准品
D/WN	温美梅
20080523	20080523
CHKD	刘铁楠
严恩志	20080523
NDT	20080523
NDT	20080523
IN	SCALE
UNIT	mm
	SHEET

Appearance Specification

NO.	Item	Standard	Importance Class
1	Top side of Lens	No obvious impurity and oil impurity on the front of lens within the half area; The defect(unfeeling) limitation: width \leq 1mm, length \leq 2mm, the defect number \leq 2; No feeling defect; The width of defects and gaps on the outside of Lens \leq 0.3mm. Others are unlimited.	A
2	Screw glue	Normally screw glue shall be symmetrical distributed around lens circle side. Particular circs, glue distribution must not disturb customer's assembly operation.	A
3	L1 Glass	No defect and dust check from 45° angle under the reflexing light and from 0° under the highlight	A
4	Holder	No obvious impurity and distortion of outline. The width and length of defect is unlimited, the depth \leq 0.1mm and \leq 1/4 of the thickness of Holder.	B
5	Sealed glue	Sealed glue distributing between holder and FPC must be symmetrical and smooth. Not allow glue leakage and asymmetric thickness. After holder assembly, the thickness distance between one side and its opposite side shall be less than 0.2mm. Excess glue over the holder shall not make the outside dimension be out of control.	A
6	FPC/PCB	Edge defect limitation: width \leq 1/2H (H is minimum.)、 length \leq 1mm、 defect numbers per edge \leq 2(No tearing gap inby edge for FPC); Edge outshoot limitation (width \leq 0.3mm, length \leq 1mm). No obvious impurity and crease on the surface. If there was shield film on the surface, the spot size of the film shall be less than 0.3mm \times 1mm and no line is exposed. If it was not be cleaned and did not influence the total thickness, it would be permitted. Label and mark shall be clear enough to be discerned.	A
7	Connector	No dust, fingerprint, and not allows to turning colors, distortion; Solder must be well; No open circuit or short circuit	A

8	Gold finger	No dust, fingerprint, and not allows to turning colors, burned, unsmoothed and peeled; No open circuit or short circuit; The defect width shall be smaller than 20% of gold finger's width. No copper/nickel exposed in defect. Numbers of defected pin shall be less than 3. The defect limitation:width≤0.08mm,length≤5mm.	A
9	Stiffener	Holder anchor pole length overtopping the steel plate shall be less than 0.2mm. No dust, rust and deep scratch on the steel surface without Double coated tapes.	B
10	Double coated tapes	Adhered direction shall be right. Not allows to excess steel plate edge. No alveoli and stick. Not allows to peel glue and rip protective paper when tear the protective paper.	B
11	Protective film	No dust in the glue side. Not allows to float or drop. Adhered direction shall be right.	B

Remark:

1. The definition of the appearance importance class

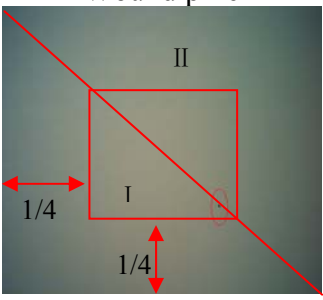
A: The defect can be found in the finished product, or have obvious visual differences from good products, such as crack, defect and dust, or influence image quality, or are appointed by the customer. We will emphasize these items and check all products.

B: The defect can be found in the finished product and has visual difference from the good one, but will not affect customer's aesthetic judgement. Or the defect can not be found in the finished product and will not generate functional problem, but will slightly influence sequential manufacture process or condition. We will supervise these items in the manufacturing process and check products selectively.

2. Sampling standard

Referenced standard: GB/T 2828.1-2003/ISO 2859-1:1999 and ANSI/ASQC.4-1993 II

Image Specification

NO.	Item	Standard	Important Class
1	TV Line	Center \geq 1250 8 point of 0.7 viewing field \geq 1000	A
2	Shading	The lightness of 90% viewing area \geq 40% of center lightness(Lens correction Shading [Turn off]); The lightness of 90% viewing area \geq 60% of center lightness(Lens correction Shading [Turn on])	A
3	Dust	No dust in the center viewing area; Border area according to the limit samples	A
4	Dead pixel	No in the viewing area.	A
5	<p>Wound pixel</p>  <p>The diagram shows a square region divided by a diagonal line. Region I is the lower-left triangle, and Region II is the upper-right triangle. Red arrows indicate the width and height of Region I are both 1/4.</p>	<p>I area: Blemish number \leq 1 II area: Blemish number \leq 4</p>	B
6	Color	Color distortion ratio of center \pm 15%	B
7	Gray Scale	Margin of two near scales' brightness \geq 6	B
8	Distortion	$<$ 1%	B
9	Flare	No flare in 45° viewing angle; No ghost in full viewing angle	B

QA Plan

NO.	Item	Sampling frequency	Measure	Remark
Image and reliability item				
1	TV Line	AQL 0.65 II Class	Same as production	100% Inspection
2	Shading	AQL 0.65 II Class	Same as production	100% Inspection
3	Dust	AQL 0.65 II Class	Same as production	100% Inspection
4	Dead pixel	AQL 0.65 II Class	Same as production	100% Inspection
5	Wound pixel	AQL 1.5 II Class	Same as production	100% Inspection
6	Color	AQL 1.5 II Class	Same as production	100% Inspection
7	Gray Scale	AQL 1.5 II Class	Same as production	100% Inspection
8	Distortion	N=5,c=0 per batch	Same as production	Sampling by QA
9	Flare	N=5,c=0 per batch	Same as production	Sampling by QA
Appearance Check Items				
1	Top side of Lens	AQL 1.0 II Class	Same as production	100% Inspection
2	Screw glue	AQL 1.0 II Class	Same as production	100% Inspection
3	L1 Glass	AQL 1.0 II Class	Same as production	100% Inspection
4	Holder	AQL 1.5 II Class	Same as production	100% Inspection
5	Sealed glue	AQL 1.0 II Class	Same as production	100% Inspection
6	FPC/PCB	AQL 1.0 II Class	Same as production	100% Inspection
7	Connector	AQL 1.0 II Class	Same as production	100% Inspection
8	Gold finger	AQL 1.0 II Class	Same as production	100% Inspection
9	Stiffener	AQL 1.5 II Class	Same as production	100% Inspection
10	Double coated tapes	AQL 1.5 II Class	Same as production	100% Inspection
11	Protective film	AQL 1.5 II Class	Same as production	100% Inspection

Sample:

Referenced standard: GB/T 2828.1-2003/ISO 2859-1:1999 and ANSI/ASQC.4-1993 II

PRECAUTIONS FOR USING CCM MODULES

Handing Precautions

—DO NOT try to open the unit enclosure as there is no user-serviceable component inside. To prevent damage to the camera module by electrostatic discharge, handling the camera module only after discharging all static electricity from yourself and ensuring a static-free environment for the camera module.

—DO NOT touch the top surface of the lens.

—DO NOT press down on the lens.

—DO NOT try to focus the lens.

—DO NOT put the camera module in a dusty environment.

—To reduce the risk of electrical shock and damage to the camera module, turn off the power before connect and disconnect the camera module.

—DO NOT drop the camera module more than 60 cm onto any hard surface.

—DO NOT expose camera module to rain or moisture.

—DO NOT expose camera module to direct sunlight.

—DO NOT put camera in a high temperature environment.

—DO NOT use liquid or aerosol cleaners to clean the lens.

—DO NOT make any charges or modifications to camera module.

—DO NOT subject camera module to strong electromagnetic field.

—DO NOT subject the camera module to excessive vibration or shock.

—DO NOT Impact or nip CCM module with spiculate things

—DO NOT alter, modify or change the shape of the tab on the metal frame.

—DO NOT make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

—DO NOT damage or modify the pattern writing on the printed circuit board.

—Absolutely DO NOT modify the zebra rubber strip (conductive rubber) or heat seal connector

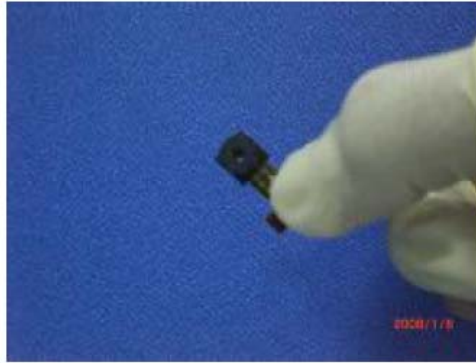
—Except for soldering the interface, DO NOT make any alterations or modifications with a soldering iron.

—DO NOT twist FPC of CCM.

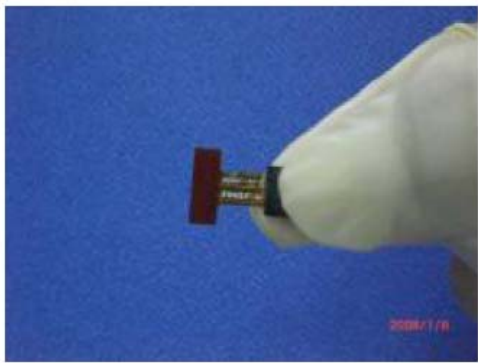
Apply indication



Correct



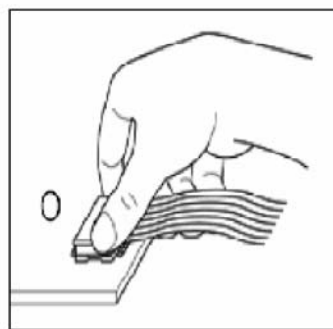
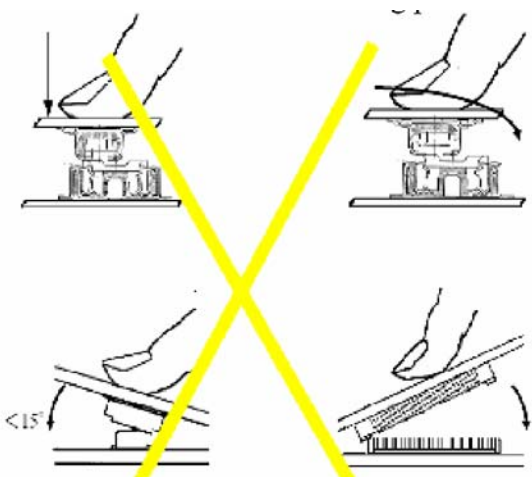
Incorrect



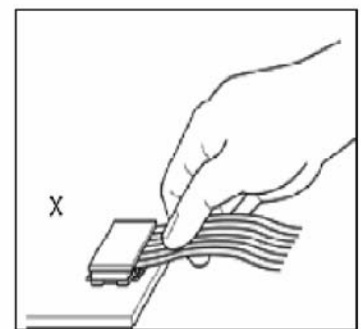
Incorrect

Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows

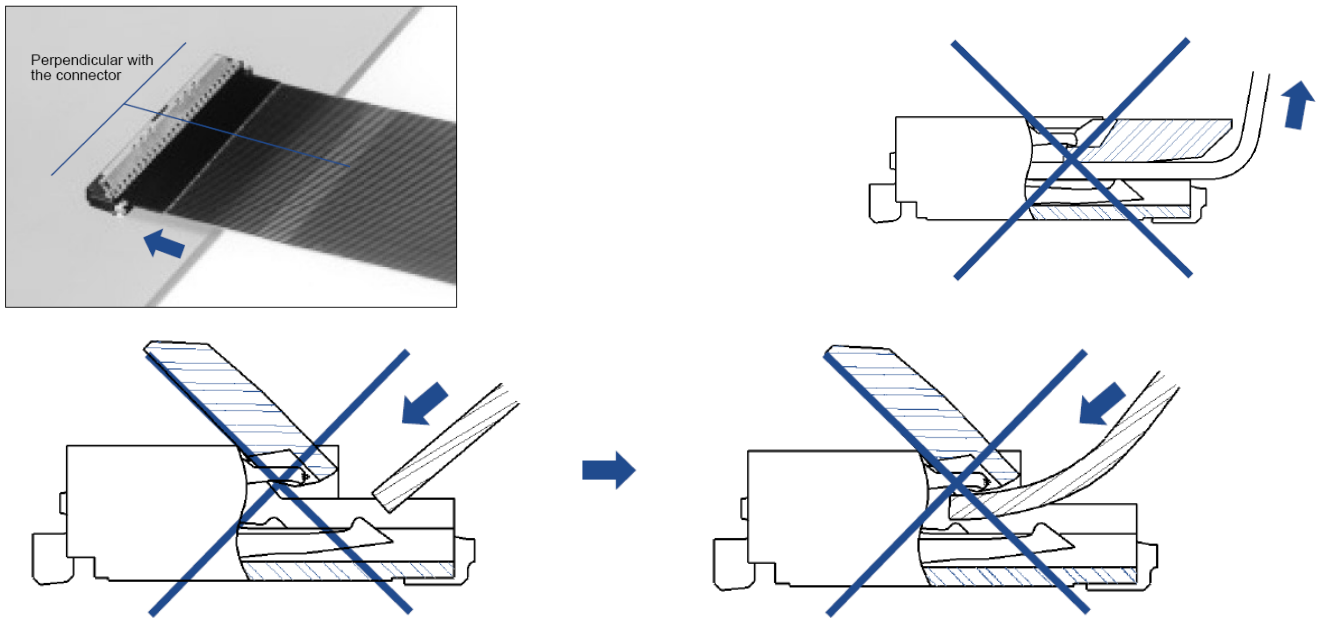


OK



NG

Precaution for assemble the module with ZIF connector:



Precaution for soldering the CCM:

	Manual soldering	Machine drag soldering	Machine press soldering
No ROHS product	290°C ~350°C. Time: 3-5S.	330°C ~350°C. Speed: 4-8 mm/s.	300°C ~330°C. Time: 3-6S. Press: 0.8~1.2Mpa
ROHS product	340°C ~370°C. Time: 3-5S.	350°C ~370°C. Speed: 4-8 mm/s.	330°C ~360°C. Time: 3-6S. Press: 0.8~1.2Mpa

- (1) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the lens surface with a cover during soldering to prevent any damage due to flux spatters.
- (2) The CCM module and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.

Other precautions

For correct using please refer to the relative criterions of electronic products.

Limited Warranty

Unless agreed between TRULY and customer, TRULY will replace or repair any of its CCM modules which are found to be functionally defective when inspected in accordance with TRULY CCM acceptance standards for a period of one year from date of shipments. Cosmetic/visual defects must be returned to TRULY within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of TRULY limited to repair and/or replacement on the terms set forth above. TRULY will not be responsible for any subsequent or consequential events.

Return CCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are:

- Holder is apart from module.
- Holder or Connector is anamorphic.
- Connector is turnup.
- FPC is lacerated or disconnection, and so on.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

Package Specification Packaging Design One

Product No.	CM8119-A500SA-E	Release date									
Product name	Compact Camera Module	Releaser									
Supplier	TRULY SEMI CONDUCTORS LTD	Recycle	<input type="checkbox"/> YES <input checked="" type="checkbox"/> NO								
Quantity/ each box	TBD	Material for box	<input checked="" type="checkbox"/> paper <input type="checkbox"/> plastic								
Outer carton box size	405mm*290mm*290mm	Box type	<input checked="" type="checkbox"/> new <input type="checkbox"/> update								
Quantity / inner box * Quantity / outer box	TBD	Weight	<table border="1"> <tr> <td></td> <td>g / pcs</td> <td>BOX=TYPE Record of SRF Dept.</td> <td>TBD</td> </tr> <tr> <td></td> <td>Kg / outer box</td> <td></td> <td>Kg(Max)</td> </tr> </table>		g / pcs	BOX=TYPE Record of SRF Dept.	TBD		Kg / outer box		Kg(Max)
	g / pcs	BOX=TYPE Record of SRF Dept.	TBD								
	Kg / outer box		Kg(Max)								

Packing Standards:

There are TBD modules each plastic plate.

There are TBD modules each inner carton box..

There are 4 each outer carton box.

Requirements of outer carton box :

1. Weight(Max): TBD Kg
2. Height (Max): 0.29 M
3. Prohibition: Box made by log

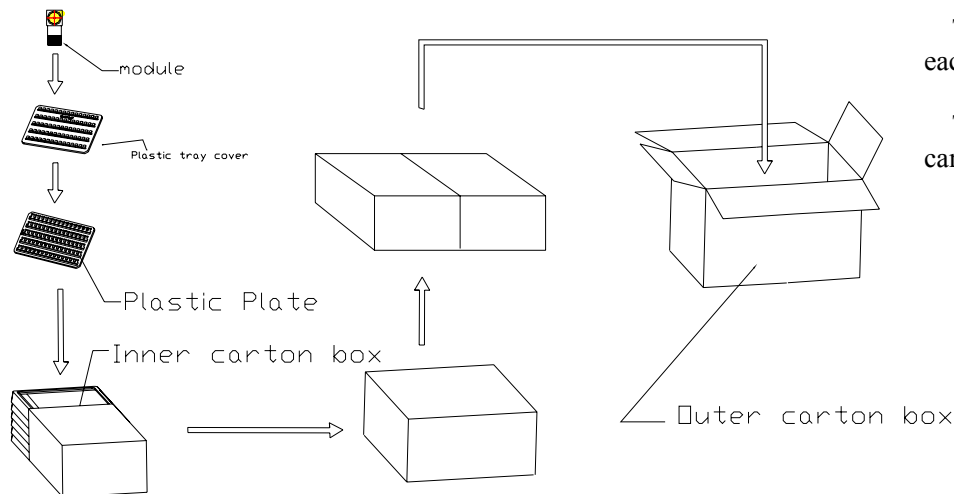
Material for Plastic tray

It is made of antistatic polystyrene which has no chemical pollution. Surface resistivity : 10^6 ohm/sq

Packaging Design Two

Product No.	CM8119-A500SA-E	Release date					
Product name	Compact Camera Module	Releaser					
Supplier	TRULY SEMI CONDUCTORS LTD	Recycle	<input type="checkbox"/> YES <input checked="" type="checkbox"/> NO				
Quantity/ each box	TBD	Material for box	<input checked="" type="checkbox"/> paper <input type="checkbox"/> plastic				
Outer carton box size	405 mm *290 mm *170 mm	Box type	<input checked="" type="checkbox"/> new <input type="checkbox"/> update				
Quantity / inner box * Quantity / outer box	TBD	Weight	<table border="1"> <tr> <td>g / pcs</td> <td rowspan="2">BOX=TYPE Record of SRF Dept.</td> <td rowspan="2">TBD Kg(Max)</td> </tr> <tr> <td>Kg / outer box</td> </tr> </table>	g / pcs	BOX=TYPE Record of SRF Dept.	TBD Kg(Max)	Kg / outer box
g / pcs	BOX=TYPE Record of SRF Dept.	TBD Kg(Max)					
Kg / outer box							

Packing Standards:



There are TBD modules each plastic plate.

There are TBD modules each inner carton box..

There are 2 each outer carton box.

Requirements of outer carton box :

4. Weight(Max): TBD Kg
5. Height (Max): 0.17 M
6. Prohibition: Box made by log

Material for Plastic tray

It is made of antistatic polystyrene which has no chemical pollution. Surface resistivity : 10^6 ohm/sq

PRIOR CONSULT MATTER

- 1.①For Truly standard products, we keep the right to change material, process for improving the product property without notice on our customer.
②For OEM products, if any change needed which may affect the product property, we will consult with our customer in advance.
2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.

FACTORY CONTACT INFORMATION

FACTORY NAME: TRULY SEMICONDUCTORS LTD.

FACTORY ADDRESS: Truly Industrial Area, ShanWei City, GuangDong, China

FACTORY PHONE: 86-0660-3380061 **FAX:** 86-0660-3371772